



Absolute Maximum Ra**q**en-US



Electrical Characteristics T_{vj} =25°C, unless otherwise noted

| Parameter | Symbol | Test condition | Min. | Тур. | Max. | Unit |
|--------------------------------------|----------------------|--|------|------|------|------|
| OFF | | | - | | | ·I |
| Collector Emitter Breakdown Voltage | BV _{CES} | $V_{GE} = 0V, I_C = 1mA$ | 1350 | | | V |
| Zero Gate Voltage Collector Current | I _{CES} | V _{CE} = 1350V, V _{GE} = 0V | | | 1 | mA |
| Gate Emitter Leakage Current | I _{GES} | $V_{CE} = 0V, V_{GE} = 25V$ | | | 500 | nA |
| Integrated Gate Resistor | R _{G(int)} | f = 1MHz, open Collector | | 5.3 | | |
| ON | | | | | | |
| Gate Emitter Threshold Voltage | V _{GE(TH)} | $V_{GE} = V_{CE}$, $I_C = 30$ mA | 5.0 | 6.5 | 8.0 | V |
| Collector Emitter Saturation Voltage | V _{CE(SAT)} | $V_{GE} = 15V, I_C = 30A, T_{vj} = 25$ | | 1.80 | 2.20 | V |
| | | $V_{GE} = 15V, I_C = 30A, T_{vj} = 125$ | | 2.12 | | |
| | | $V_{GE} = 15V, I_C = 30A, T_{vj} = 175$ | | 2.35 | | |
| Diode Forward Voltage | V _{FM} | $I_F = 30A, T_{vj} = 25$ | | 2.37 | | V |
| | | $I_F = 30A, T_{vj} = 125$ | | 2.61 | | |
| | | $I_F = 30A, T_{vj} = 175$ | | 2.78 | | |
| DYNAMIC | | | | | | |
| Input Capacitance | C _{IES} | V _{CE} = 30V, | | 3675 | | pF |
| Output Capacitance | C _{OES} | $V_{GE} = 0V$ | | 57 | | |
| Reverse Transfer Capacitance | C _{RES} | f = 1MHz | | 44 | | |
| Total Gate Charge | Qg | | | 166 | 249 | nC |
| Gate-Emitter Charge | Q _{ge} | $V_{CC} = 600 \text{V}, I_{C} = 30 \text{A}$ $V_{GF} = 15 \text{V}$ | | 23 | 34 | |
| Gate-Collector Charge | Q _{gc} | v GE - 10 v | | 71 | 106 | |





Reverse Conducting Field Stop Trench IGBT

Electrical Characteristics $T_{\nu j}$ =25°C, unless otherwise noted

| Parameter | Symbol | Test condition | Min. | Тур. | Max. | Unit |
|--------------------|--------|----------------|------|------|------|------|
| SWITCHING (Note 2) | , | | 1 | 1 | | |
| Turn | | | | | | |
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Fig. 1 IGBT Output Characteristics

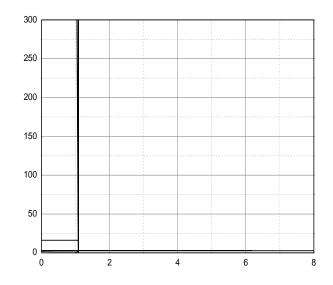


Fig. 2 IGBT Output Characteristics

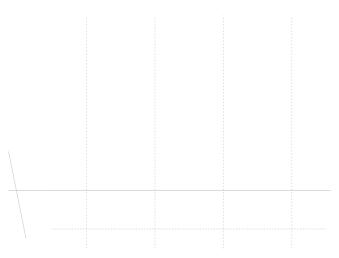


Fig. 3 IGBT Saturation Voltage vs. Junction Temperature Fig. 4 IGBT Threshold Voltage vs. Junction Temperature

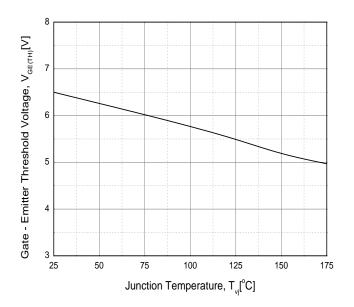




Fig. 5 IGBT Transfer Characteristic

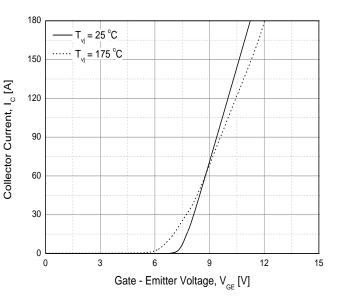


Fig. 6 IGBT Capacitance Characteristics

Fig. 7 Diode Conduction Characteristics

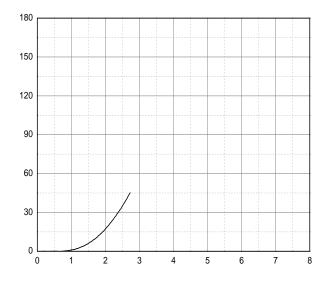
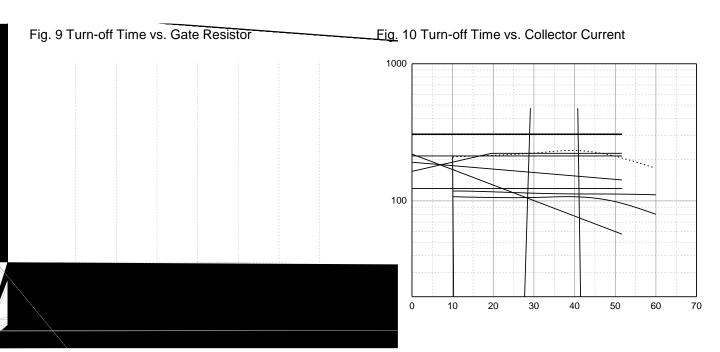


Fig. 8 Diode Forward Voltage vs. Junction Temperature







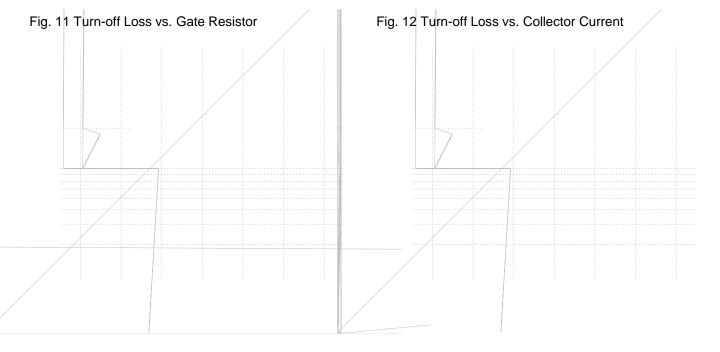




Fig. 13 Gate Charge Characteristics

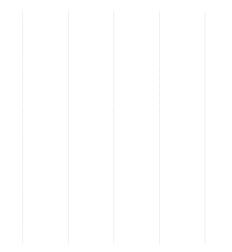


Fig. 14 Transient Thermal Impedance

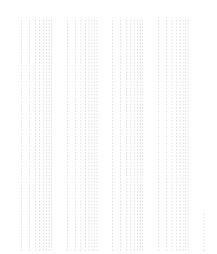


Fig. 15 Power Dissipation vs. Case Temperature

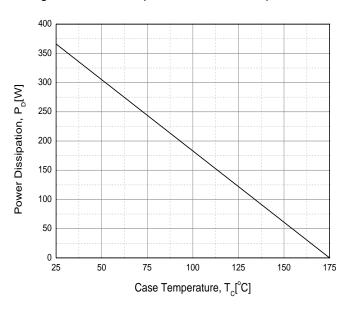


Fig. 16 Collector Current vs. Case Temperature

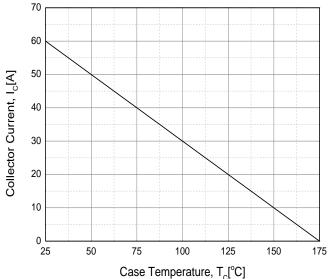




Fig. 17 SOA

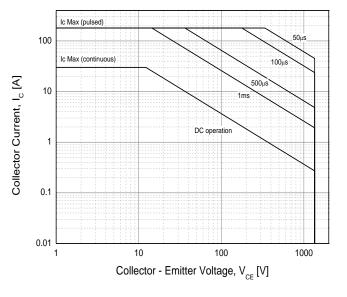


Fig. 18 RBSOA

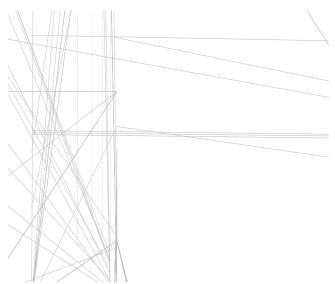


Fig. 19 Load Current vs. Frequency

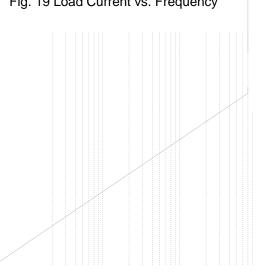
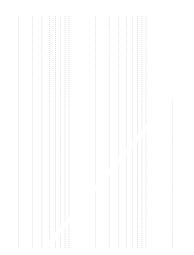
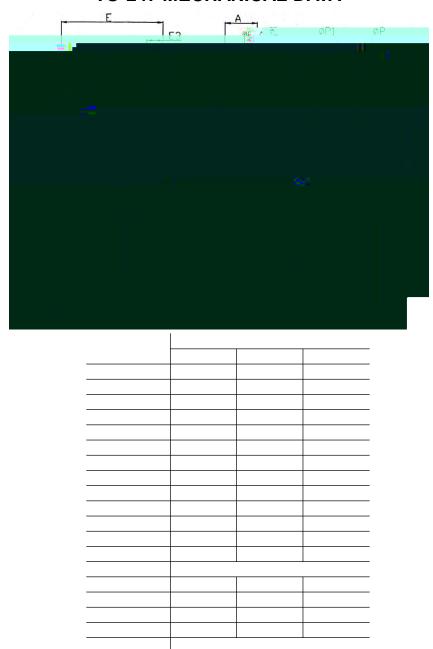


Fig. 20 Load Current vs. Frequency





TO-247 MECHANICAL DATA



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